12/03/2013 502588208

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2634356

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LUP SAN LEONG	11/25/2013
ALAN CING GIE LIM	11/26/2013
LING WU	11/25/2013
JIAN BO LANG	11/25/2013

RECEIVING PARTY DATA

Name:	GLOBALFOUNDRIES SINGAPORE PTE. LTD.
Street Address:	60 WOODLANDS INDUSTRIAL PARK D STREET 2
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	738406

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14092217

CORRESPONDENCE DATA

Fax Number: (480)385-5061 Phone: 4803855060

Email: mbartnek@ifllaw.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: INGRASSIA FISHER & LORENZ, P.C.

Address Line 1: 7010 E. COCHISE ROAD

Address Line 4: SCOTTSDALE, ARIZONA 85253

ATTORNEY DOCKET NUMBER:	126.0017 (ESG016)
NAME OF SUBMITTER:	RYAN T. FORTIN
Signature:	/Ryan T. Fortin/
	PATENT

REEL: 031704 FRAME: 0295 502588208

Date:	12/03/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 4 source=20131203_Assignment#page1.tif source=20131203_Assignment#page2.tif source=20131203_Assignment#page3.tif source=20131203_Assignment#page4.tif	

PATENT REEL: 031704 FRAME: 0296

COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	METHODS FOR FABRICATING INTEGRATED CIRCUITS USING CHEMICAL MECHANICAL POLISHING	
DECLARATION		
As the below	named inventor, I hereby declare that:	
This declarati	on The attached application, or	
	United States application or PCT international application numberfiled on	
The above-ide	entified application was made or authorized to be made by me.	
I believe that	I am the original inventor or an original joint inventor of a claimed invention in the application.	
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.		
I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.		
	ASSIGNMENT	
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-inparts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.		
If any portion of this Combined Declaration or Assignment is held unenforceable, then remaining portions hereof shall nevertheless remain in full force and effect.		
LEGAL NAM	NE OF INVENTOR (Last name, First name, Middle Name)	
Inventor: 150NG 141P SON Date: 25-Nov-2013		
Signature:		
	cation data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form.	

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	ASSIGNMENT	
For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-inparts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.		
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LEGAL NAM	ME OF INVENTOR (Last name, First name, Middle Name)	
Inventor: \(\frac{\mathcal{M} \mathcal{M} \frac{\mathcal{M} \mathcal{M} \frac{\mathcal{M}}{\mathcal{M}} \frac{\mathcal{M}}{\mathcal{M}} \]		
Signature:	AGMS /	
Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use an additional form for each additional inventor.		

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ASSIGNMENT For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, transfer, to GLOBALFOUNDRIES Singapore Pte. Ltd. having a business address of 60 Woodlands Industrial Park D Street 2, Singapore 738406 its successors and assigns, absolutely and forever, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue in the United States and/or any foreign countries, and any reissues, re-examinations, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that may be issued or granted, and all right, title and interest to the inventions contained in said Patents and Applications, for the United States and all foreign countries, and all the rights and privileges relating thereto including but not limited to the priority rights arising from said Applications, the right to recover and take all such proceedings as may be necessary for the recovery of damages or otherwise in respect of past, present and future infringement, and the right to apply for, take and maintain patents on said inventions.		
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LEGAL NAME OF INVENTOR (Last name, First name)		
Inventor:	WU LING Date: 25-Nov-2013	
Signature:		
	cation data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form.	

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As the below	named inventor, I hereby declare that:
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LEGAL NAM Inventor: Signature:	TE OF INVENTOR (First name, Last name, Middle Name) Date: 36/11/30/3
Note: An appli Use an addition	cation data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. al form for each additional inventor.